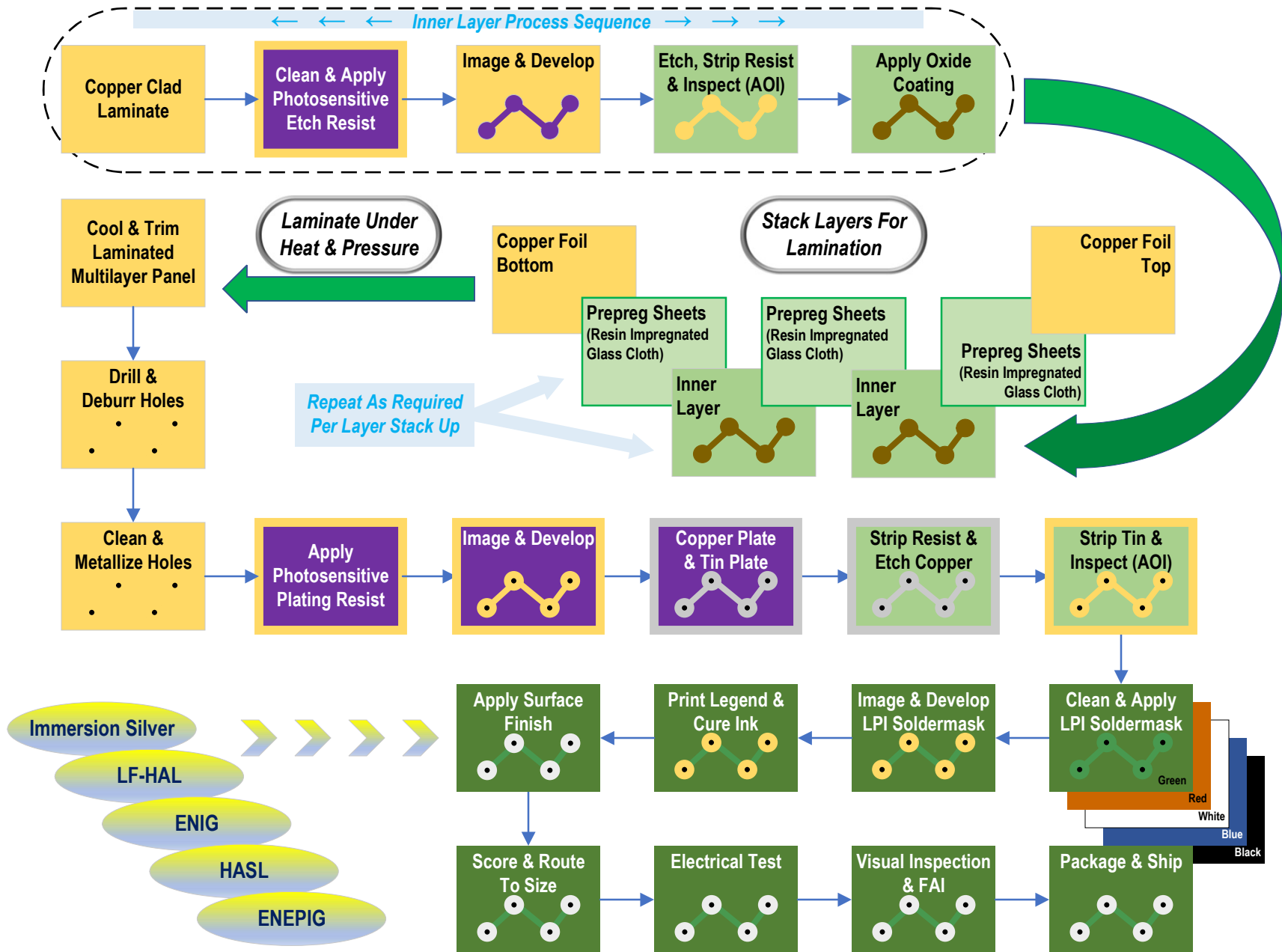


# Basic Multilayer Flow Chart



Blind Vias, Buried Vias, Filled Vias and other higher technologies use these same processes in differing sequences and may be augmented by additional specialty processes such as Planerization, Laser Drilling, Controlled Depth Drilling, etc. Double Sided boards begin at **Copper Clad Laminate** followed by **Drill & Deburr Holes**.